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Details

Product Status	Last Time Buy
Core Processor	XC800
Core Size	8-Bit
Speed	86MHz
Connectivity	SSI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	19
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	38-TFSOP (0.173", 4.40mm Width)
Supplier Device Package	PG-TSSOP-38
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/xc8662fribefxuma1

1 Summary of Features

- High-performance XC800 Core
 - compatible with standard 8051 processor
 - two clocks per machine cycle architecture (for memory access without wait state)
 - two data pointers
- On-chip memory
 - 8 Kbytes of Boot ROM
 - 256 bytes of RAM
 - 512 bytes of XRAM
 - 4/8/16 Kbytes of Flash; or
8/16 Kbytes of ROM, with additional 4 Kbytes of Flash
(includes memory protection strategy)
- I/O port supply at 3.3 V/5.0 V and core logic supply at 2.5 V (generated by embedded voltage regulator)

(further features are on next page)

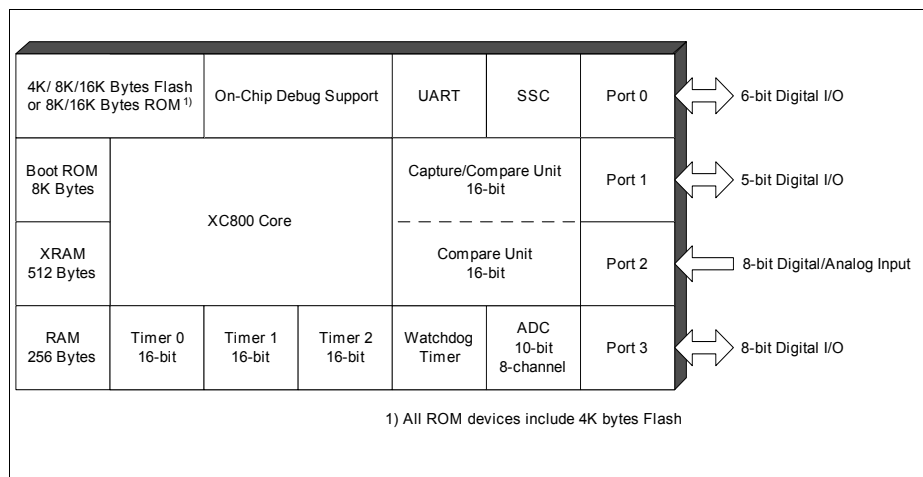


Figure 1 XC866 Functional Units

General Device Information

Table 3 Pin Definitions and Functions (cont'd)

Symbol	Pin Number	Type	Reset State	Function
P3		I		Port 3 Port 3 is a bidirectional general purpose I/O port. It can be used as alternate functions for the CCU6.
P3.0	32		Hi-Z	CCPOS1_2 CCU6 Hall Input 1 CC60_0 Input/Output of Capture/Compare channel 0
P3.1	33		Hi-Z	CCPOS0_2 CCU6 Hall Input 0 CC61_2 Input/Output of Capture/Compare channel 1 COUT60_0 Output of Capture/Compare channel 0
P3.2	34		Hi-Z	CCPOS2_2 CCU6 Hall Input 2 CC61_0 Input/Output of Capture/Compare channel 1
P3.3	35		Hi-Z	COUT61_0 Output of Capture/Compare channel 1
P3.4	36		Hi-Z	CC62_0 Input/Output of Capture/Compare channel 2
P3.5	37		Hi-Z	COUT62_0 Output of Capture/Compare channel 2
P3.6	30		PD	<u>CTRAP_0</u> CCU6 Trap Input
P3.7	31		Hi-Z	EXINT4 External Interrupt Input 4 COUT63_0 Output of Capture/Compare channel 3

3.2 Memory Organization

The XC866 CPU operates in the following five address spaces:

- 8 Kbytes of Boot ROM program memory
- 256 bytes of internal RAM data memory
- 512 bytes of XRAM memory
(XRAM can be read/written as program memory or external data memory)
- a 128-byte Special Function Register area
- 4/8/16 Kbytes of Flash program memory (Flash devices); or
8/16 Kbytes of ROM program memory, with additional 4 Kbytes of Flash (ROM devices)

Figure 6 illustrates the memory address spaces of the XC866-4FR device.

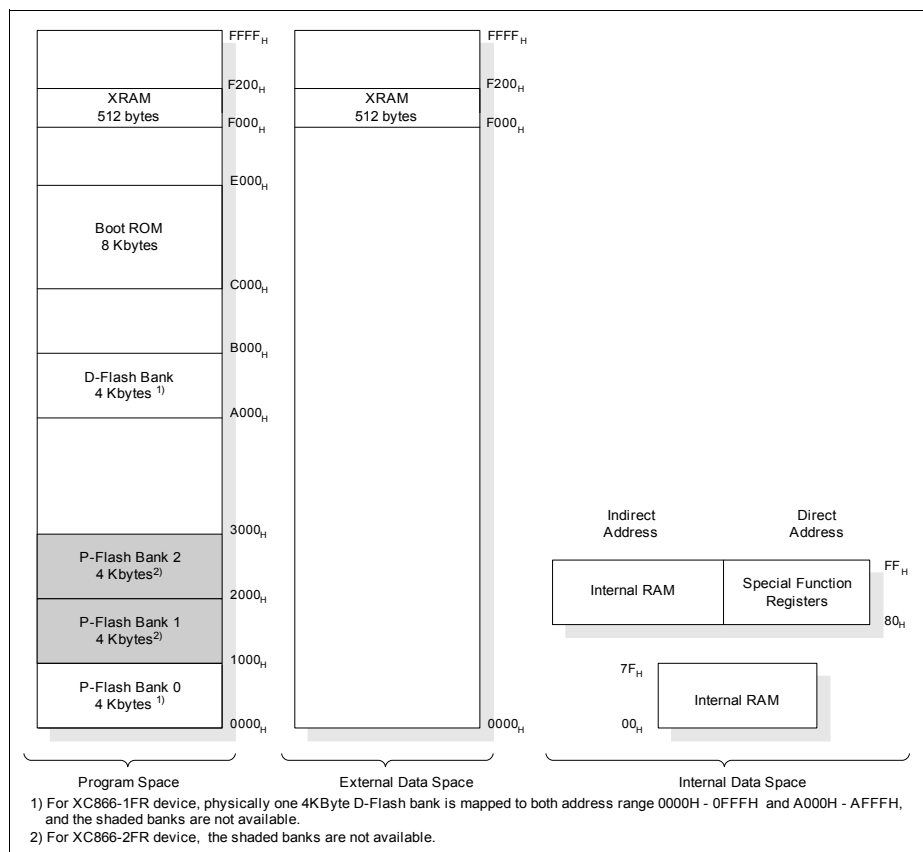


Figure 6 Memory Map of XC866 Flash Devices

Table 5 Flash Protection Type for XC866-2FR and XC866-4FR devices

PASSWORD	Type of Protection	Flash Banks to Erase when Unprotected
1XXXXXXX _B	Flash Protection Mode 1	All Banks
0XXXXXXX _B	Flash Protection Mode 0	P-Flash Bank

For XC866-1FR device and ROM devices:

The selection of protection type is summarized in **Table 6**.

Table 6 Flash Protection Type for XC866-1FR device and ROM devices

PASSWORD	Type of Protection (Applicable to the whole Flash)	Sectors to Erase when Unprotected	Comments
1XXXXXXX _B	Read/Program/Erase	All Sectors	Compatible to Protection mode 1
00001XXX _B	Erase	Sector 0	
00010XXX _B	Erase	Sector 0 and 1	
00011XXX _B	Erase	Sector 0 to 2	
00100XXX _B	Erase	Sector 0 to 3	
00101XXX _B	Erase	Sector 0 to 4	
00110XXX _B	Erase	Sector 0 to 5	
00111XXX _B	Erase	Sector 0 to 6	
01000XXX _B	Erase	Sector 0 to 7	
01001XXX _B	Erase	Sector 0 to 8	
01010XXX _B	Erase	All Sectors	
Others	Erase	None	

Although no protection scheme can be considered infallible, the XC866 memory protection strategy provides a very high level of protection for a general purpose microcontroller.

Functional Description

In order to access a register located in a page different from the actual one, the current page must be left. This is done by reprogramming the bit field PAGE in the page register. Only then can the desired access be performed.

If an interrupt routine is initiated between the page register access and the module register access, and the interrupt needs to access a register located in another page, the current page setting can be saved, the new one programmed and finally, the old page setting restored. This is possible with the storage fields STx (x = 0 - 3) for the save and restore action of the current page setting. By indicating which storage bit field should be used in parallel with the new page value, a single write operation can:

- Save the contents of PAGE in STx before overwriting with the new value (this is done in the beginning of the interrupt routine to save the current page setting and program the new page number); or
- Overwrite the contents of PAGE with the contents of STx, ignoring the value written to the bit positions of PAGE (this is done at the end of the interrupt routine to restore the previous page setting before the interrupt occurred)

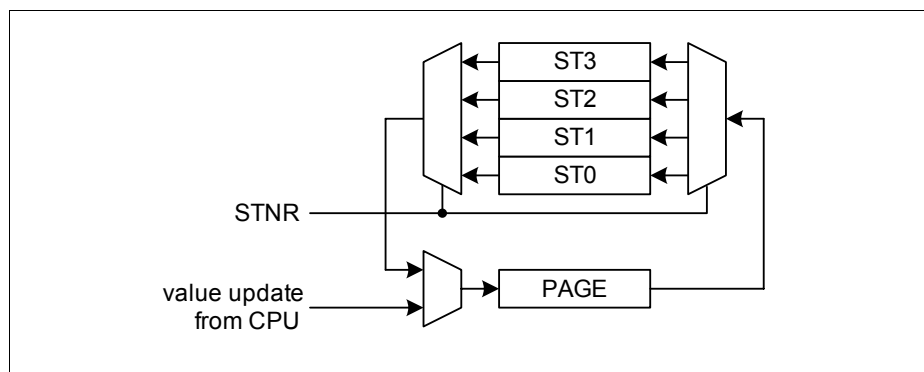


Figure 10 Storage Elements for Paging

With this mechanism, a certain number of interrupt routines (or other routines) can perform page changes without reading and storing the previously used page information. The use of only write operations makes the system simpler and faster. Consequently, this mechanism significantly improves the performance of short interrupt routines.

The XC866 supports local address extension for:

- Parallel Ports
- Analog-to-Digital Converter (ADC)
- Capture/Compare Unit 6 (CCU6)
- System Control Registers

3.2.4 XC866 Register Overview

The SFRs of the XC866 are organized into groups according to their functional units. The contents (bits) of the SFRs are summarized in **Table 7** to **Table 15**, with the addresses of the bitaddressable SFRs appearing in bold typeface.

The CPU SFRs can be accessed in both the standard and mapped memory areas (RMAP = 0 or 1).

Table 7 CPU Register Overview

Addr	Register Name		Bit	7	6	5	4	3	2	1	0
RMAP = 0 or 1											
81 _H	SP Stack Pointer Register	Reset: 07_H	Bit Field	SP							
			Type	rw							
82 _H	DPL Data Pointer Register Low	Reset: 00_H	Bit Field	DPL7	DPL6	DPL5	DPL4	DPL3	DPL2	DPL1	DPL0
			Type	rw	rw	rw	rw	rw	rw	rw	rw
83 _H	DPH Data Pointer Register High	Reset: 00_H	Bit Field	DPH7	DPH6	DPH5	DPH4	DPH3	DPH2	DPH1	DPH0
			Type	rw	rw	rw	rw	rw	rw	rw	rw
87 _H	PCON Power Control Register	Reset: 00_H	Bit Field	SMOD	0			GF1	GF0	0	IDLE
			Type	rw	r			rw	rw	r	rw
88 _H	TCON Timer Control Register	Reset: 00_H	Bit Field	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
			Type	rwh	rw	rwh	rw	rwh	rw	rwh	rw
89 _H	TMOD Timer Mode Register	Reset: 00_H	Bit Field	GATE1	0	T1M		GATE0	0	T0M	
			Type	rw	r	rw		rw	r	rw	
8A _H	TL0 Timer 0 Register Low	Reset: 00_H	Bit Field	VAL							
			Type	rwh							
8B _H	TL1 Timer 1 Register Low	Reset: 00_H	Bit Field	VAL							
			Type	rwh							
8C _H	TH0 Timer 0 Register High	Reset: 00_H	Bit Field	VAL							
			Type	rwh							
8D _H	TH1 Timer 1 Register High	Reset: 00_H	Bit Field	VAL							
			Type	rwh							
98 _H	SCON Serial Channel Control Register	Reset: 00_H	Bit Field	SM0	SM1	SM2	REN	TB8	RB8	TI	RI
			Type	rw	rw	rw	rw	rw	rwh	rwh	rwh
99 _H	SBUF Serial Data Buffer Register	Reset: 00_H	Bit Field	VAL							
			Type	rwh							
A2 _H	EO Extended Operation Register	Reset: 00_H	Bit Field	0			TRAP EN	0			DPSEL 0
			Type	r			rw	r			rw
A8 _H	IEN0 Interrupt Enable Register 0	Reset: 00_H	Bit Field	EA	0	ET2	ES	ET1	EX1	ET0	EX0
			Type	rw	r	rw	rw	rw	rw	rw	rw
B8 _H	IP Interrupt Priority Register	Reset: 00_H	Bit Field	0		PT2	PS	PT1	PX1	PT0	PX0
			Type	r		rw	rw	rw	rw	rw	rw
B9 _H	IPH Interrupt Priority Register High	Reset: 00_H	Bit Field	0		PT2H	PSH	PT1H	PX1H	PT0H	PX0H
			Type	r		rw	rw	rw	rw	rw	rw
D0 _H	PSW Program Status Word Register	Reset: 00_H	Bit Field	CY	AC	F0	RS1	RS0	OV	F1	P
			Type	rw	rwh	rwh	rw	rw	rwh	rwh	rh
E0 _H	ACC Accumulator Register	Reset: 00_H	Bit Field	ACC7	ACC6	ACC5	ACC4	ACC3	ACC2	ACC1	ACC0
			Type	rw	rw	rw	rw	rw	rw	rw	rw
E8 _H	IEN1 Interrupt Enable Register 1	Reset: 00_H	Bit Field	ECCIP 3	ECCIP 2	ECCIP 1	ECCIP 0	EXM	EX2	ESSC	EADC
			Type	rw	rw	rw	rw	rw	rw	rw	rw

Functional Description
Table 7 CPU Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
F0 _H	B B Register Reset: 00 _H	Bit Field	B7	B6	B5	B4	B3	B2	B1	B0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F8 _H	IP1 Interrupt Priority Register 1 Reset: 00 _H	Bit Field	PCCIP 3	PCCIP 2	PCCIP 1	PCCIP 0	PXM	PX2	PSSC	PADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F9 _H	IPH1 Interrupt Priority Register 1 High Reset: 00 _H	Bit Field	PCCIP 3H	PCCIP 2H	PCCIP 1H	PCCIP 0H	PXMH	PX2H	PSSCH	PADC H
		Type	rw	rw	rw	rw	rw	rw	rw	rw

The system control SFRs can be accessed in the standard memory area (RMAP = 0).

Table 8 System Control Register Overview

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 0 or 1										
8F _H	SYSCON0 System Control Register 0 Reset: 00_H	Bit Field	0							RMAP
		Type	r							rw
RMAP = 0										
BF _H	SCU_PAGE Page Register for System Control Reset: 00_H	Bit Field	OP		STNR		0	PAGE		
		Type	w		w		r	rwh		
RMAP = 0, Page 0										
B3 _H	MODPISEL Peripheral Input Select Register Reset: 00_H	Bit Field	0		JTAG TDIS	JTAG TCKS	0		EXINT OIS	URRIS
		Type	r		rw	rw	r		rw	rw
B4 _H	IRCON0 Interrupt Request Register 0 Reset: 00_H	Bit Field	0	EXINT 6	EXINT 5	EXINT 4	EXINT 3	EXINT 2	EXINT 1	EXINT 0
		Type	r	rwh	rwh	rwh	rwh	rwh	rwh	rwh
B5 _H	IRCON1 Interrupt Request Register 1 Reset: 00_H	Bit Field	0			ADCS RC1	ADCS RC0	RIR	TIR	EIR
		Type	r			rwh	rwh	rwh	rwh	rwh
B7 _H	EXICON0 External Interrupt Control Register 0 Reset: 00_H	Bit Field	EXINT3		EXINT2		EXINT1		EXINT0	
		Type	rw		rw		rw		rw	
BA _H	EXICON1 External Interrupt Control Register 1 Reset: 00_H	Bit Field	0		EXINT6		EXINT5		EXINT4	
		Type	r		rw		rw		rw	
BB _H	NMICON NMI Control Register Reset: 00_H	Bit Field	0	NMI ECC	NMI VDDP	NMI VDD	NMI OCDS	NMI FLASH	NMI PLL	NMI WDT
		Type	r	rw	rw	rw	rw	rw	rw	rw
BC _H	NMISR NMI Status Register Reset: 00_H	Bit Field	0	FNMI ECC	FNMI VDDP	FNMI VDD	FNMI OCDS	FNMI FLASH	FNMI PLL	FNMI WDT
		Type	r	rwh	rwh	rwh	rwh	rwh	rwh	rwh
BD _H	BCON Baud Rate Control Register Reset: 00_H	Bit Field	BGSEL		0		BREN		BRPRE	
		Type	rw		r		rw		rw	
BE _H	BG Baud Rate Timer/Reload Register Reset: 00_H	Bit Field	BR_VALUE							
		Type	rw							
E9 _H	FDCON Fractional Divider Control Register Reset: 00_H	Bit Field	BGS	SYNEN	ERRSY N	EOFSY N	BRK	NDOV	FDM	FDEN
		Type	rw	rw	rwh	rwh	rwh	rwh	rw	rw
EA _H	FDSTEP Fractional Divider Reload Register Reset: 00_H	Bit Field	STEP							
		Type	rw							
EB _H	FDRES Fractional Divider Result Register Reset: 00_H	Bit Field	RESULT							
		Type	rh							
RMAP = 0, Page 1										

Functional Description
Table 11 ADC Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
CA _H	ADC_CHINFR Reset: 00_H Channel Interrupt Flag Register	Bit Field	CHINF 7	CHINF 6	CHINF 5	CHINF 4	CHINF 3	CHINF 2	CHINF 1	CHINF 0
		Type	rh	rh	rh	rh	rh	rh	rh	rh
CB _H	ADC_CHINCR Reset: 00_H Channel Interrupt Clear Register	Bit Field	CHINC 7	CHINC 6	CHINC 5	CHINC 4	CHINC 3	CHINC 2	CHINC 1	CHINC 0
		Type	w	w	w	w	w	w	w	w
CC _H	ADC_CHINSR Reset: 00_H Channel Interrupt Set Register	Bit Field	CHINS 7	CHINS 6	CHINS 5	CHINS 4	CHINS 3	CHINS 2	CHINS 1	CHINS 0
		Type	w	w	w	w	w	w	w	w
CD _H	ADC_CHINPR Reset: 00_H Channel Interrupt Node Pointer Register	Bit Field	CHINP 7	CHINP 6	CHINP 5	CHINP 4	CHINP 3	CHINP 2	CHINP 1	CHINP 0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
CE _H	ADC_EVINFR Reset: 00_H Event Interrupt Flag Register	Bit Field	EVINF 7	EVINF 6	EVINF 5	EVINF 4	0		EVINF 1	EVINF 0
		Type	rh	rh	rh	rh	r		rh	rh
CF _H	ADC_EVINCR Reset: 00_H Event Interrupt Clear Flag Register	Bit Field	EVINC 7	EVINC 6	EVINC 5	EVINC 4	0		EVINC 1	EVINC 0
		Type	w	w	w	w	r		w	w
D2 _H	ADC_EVINSR Reset: 00_H Event Interrupt Set Flag Register	Bit Field	EVINS 7	EVINS 6	EVINS 5	EVINS 4	0		EVINS 1	EVINS 0
		Type	w	w	w	w	r		w	w
D3 _H	ADC_EVINPR Reset: 00_H Event Interrupt Node Pointer Register	Bit Field	EVINP 7	EVINP 6	EVINP 5	EVINP 4	0		EVINP 1	EVINP 0
		Type	rw	rw	rw	rw	r		rw	rw
RMAP = 0, Page 6										
CA _H	ADC_CRCR1 Reset: 00_H Conversion Request Control Register 1	Bit Field	CH7	CH6	CH5	CH4	0			
		Type	rw	rw	rw	rw	r			
CB _H	ADC_CRPR1 Reset: 00_H Conversion Request Pending Register 1	Bit Field	CHP7	CHP6	CHP5	CHP4	0			
		Type	rw	rw	rw	rw	r			
CC _H	ADC_CRMR1 Reset: 00_H Conversion Request Mode Register 1	Bit Field	Rsv	LDEV	CLR PND	SCAN	ENSI	ENTR	ENGT	
		Type	r	w	w	rw	rw	rw	rw	
CD _H	ADC_QMR0 Reset: 00_H Queue Mode Register 0	Bit Field	CEV	TREV	FLUSH	CLRV	TRMD	ENTR	ENGT	
		Type	w	w	w	w	rw	rw	rw	
CE _H	ADC_QSR0 Reset: 20_H Queue Status Register 0	Bit Field	Rsv	0	EMPTY	EV	0			
		Type	r	r	rh	rh	r			
CF _H	ADC_Q0R0 Reset: 00_H Queue 0 Register 0	Bit Field	EXTR	ENSI	RF	V	0	REQCHNR		
		Type	rh	rh	rh	rh	r	rh		
D2 _H	ADC_QBUR0 Reset: 00_H Queue Backup Register 0	Bit Field	EXTR	ENSI	RF	V	0	REQCHNR		
		Type	rh	rh	rh	rh	r	rh		
D2 _H	ADC_QINR0 Reset: 00_H Queue Input Register 0	Bit Field	EXTR	ENSI	RF	0		REQCHNR		
		Type	w	w	w	r		w		

The Timer 2 SFRs can be accessed in the standard memory area (RMAP = 0).

Table 12 Timer 2 Register Overview

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
C0 _H	T2_T2CON Reset: 00 _H Timer 2 Control Register	Bit Field	TF2	EXF2	0		EXEN2	TR2	0	CP/ RL2
		Type	rw	rw	r		rw	rw	r	rw

Functional Description
Table 13 CCU6 Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
FF _H	CCU6_TRPCTRH Reset: 00_H Trap Control Register High	Bit Field	TRPPE N	TRPEN 13	TRPEN					
		Type	rw	rw	rw					
RMAP = 0, Page 3										
9A _H	CCU6_MCMOUTL Reset: 00_H Multi-Channel Mode Output Register Low	Bit Field	0	R	MCMP					
		Type	r	rh	rh					
9B _H	CCU6_MCMOUTH Reset: 00_H Multi-Channel Mode Output Register High	Bit Field	0		CURH			EXPH		
		Type	r		rh			rh		
9C _H	CCU6_ISL Reset: 00_H Capture/Compare Interrupt Status Register Low	Bit Field	T12PM	T12OM	ICC62F	ICC62 R	ICC61F	ICC61 R	ICC60F	ICC60 R
		Type	rh	rh	rh	rh	rh	rh	rh	rh
9D _H	CCU6_ISH Reset: 00_H Capture/Compare Interrupt Status Register High	Bit Field	STR	IDLE	WHE	CHE	TRPS	TRPF	T13PM	T13CM
		Type	rh	rh	rh	rh	rh	rh	rh	rh
9E _H	CCU6_PISEL0L Reset: 00_H Port Input Select Register 0 Low	Bit Field	ISTRP		ISCC62		ISCC61		ISCC60	
		Type	rw		rw		rw		rw	
9F _H	CCU6_PISEL0H Reset: 00_H Port Input Select Register 0 High	Bit Field	IST12HR		ISPOS2		ISPOS1		ISPOS0	
		Type	rw		rw		rw		rw	
A4 _H	CCU6_PISEL2 Reset: 00_H Port Input Select Register 2	Bit Field	0						IST13HR	
		Type	r						rw	
FA _H	CCU6_T12L Reset: 00_H Timer T12 Counter Register Low	Bit Field	T12CVL							
		Type	rwh							
FB _H	CCU6_T12H Reset: 00_H Timer T12 Counter Register High	Bit Field	T12CVH							
		Type	rwh							
FC _H	CCU6_T13L Reset: 00_H Timer T13 Counter Register Low	Bit Field	T13CVL							
		Type	rwh							
FD _H	CCU6_T13H Reset: 00_H Timer T13 Counter Register High	Bit Field	T13CVH							
		Type	rwh							
FE _H	CCU6_CMPSTATL Reset: 00_H Compare State Register Low	Bit Field	0	CC63 ST	CCPO S2	CCPO S1	CCPO S0	CC62 ST	CC61 ST	CC60 ST
		Type	r	rh	rh	rh	rh	rh	rh	rh
FF _H	CCU6_CMPSTATH Reset: 00_H Compare State Register High	Bit Field	T13IM	COUT 63PS	COUT 62PS	CC62 PS	COUT 61PS	CC61 PS	COUT 60PS	CC60 PS
		Type	rwh	rwh	rwh	rwh	rwh	rwh	rwh	rwh

The SSC SFRs can be accessed in the standard memory area (RMAP = 0).

Table 14 SSC Register Overview

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 0										
A9 _H	SSC_PISEL Reset: 00 _H Port Input Select Register	Bit Field	0						CIS	SIS
		Type	r						rw	MIS
AA _H	SSC_CONL Reset: 00 _H Control Register Low <i>Programming Mode</i>	Bit Field	LB	PO	PH	HB	BM			
		Type	rw	rw	rw	rw	rw			
	<i>Operating Mode</i>	Bit Field	0						BC	
		Type	r						rh	

Functional Description
Table 14 SSC Register Overview

AB _H	SSC_CONH Control Register High <i>Programming Mode</i>	Reset: 00_H	Bit Field	EN	MS	0	AREN	BEN	PEN	REN	TEN
			Type	rw	rw	r	rw	rw	rw	rw	rw
	<i>Operating Mode</i>		Bit Field	EN	MS	0	BSY	BE	PE	RE	TE
			Type	rw	rw	r	rh	rwh	rwh	rwh	rwh
AC _H	SSC_TBL Transmitter Buffer Register Low	Reset: 00_H	Bit Field	TB_VALUE							
			Type	rw							
AD _H	SSC_RBL Receiver Buffer Register Low	Reset: 00_H	Bit Field	RB_VALUE							
			Type	rh							
AE _H	SSC_BRL Baudrate Timer Reload Register Low	Reset: 00_H	Bit Field	BR_VALUE[7:0]							
			Type	rw							
AF _H	SSC_BRH Baudrate Timer Reload Register High	Reset: 00_H	Bit Field	BR_VALUE[15:8]							
			Type	rw							

The OCDS SFRs can be accessed in the mapped memory area (RMAP = 1).

Table 15 OCDS Register Overview

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 1										
E9 _H	MMCR2 Reset: 00_H Monitor Mode Control Register 2	Bit Field	EXBC_P	EXBC	MBCO_N_P	MBCO_N	MMEP_P	MMEP	MMODE	JENA
		Type	w	rw	w	rwh	w	rwh	rh	rh
F1 _H	MMCR Reset: 00_H Monitor Mode Control Register	Bit Field	MEXIT_P	MEXIT	MSTEP_P	MSTEP	MRAM_S_P	MRAM_S	TRF	RRF
		Type	w	rwh	w	rw	w	rwh	rh	rh
F2 _H	MMSR Reset: 00_H Monitor Mode Status Register	Bit Field	MBCAM	MBCIN	EXBF	SWBF	HWB3_F	HWB2_F	HWB1_F	HWB0_F
		Type	rw	rh	rwh	rwh	rwh	rwh	rwh	rwh
F3 _H	MMBPCR Reset: 00_H BreakPoints Control Register	Bit Field	SWBC	HWB3C		HWB2C		HWB1_C	HWB0C	
		Type	rw	rw		rw		rw	rw	
F4 _H	MMICR Reset: 00_H Monitor Mode Interrupt Control Register	Bit Field	DVECT	DRETR	0		MMUIE_P	MMUIE	RRIE_P	RRIE
		Type	rwh	rwh	r		w	rw	w	rw
F5 _H	MMDR Reset: 00_H Monitor Mode Data Register <i>Receive</i> <i>Transmit</i>	Bit Field	MMRR							
		Type	rh							
		Bit Field	MMTR							
		Type	w							
F6 _H	HWBPSR Reset: 00_H Hardware Breakpoints Select Register	Bit Field	0			BPSEL_P	BPSEL			
		Type	r			w	rw			
F7 _H	HWBPDR Reset: 00_H Hardware Breakpoints Data Register	Bit Field	HWBPxx							
		Type	rw							

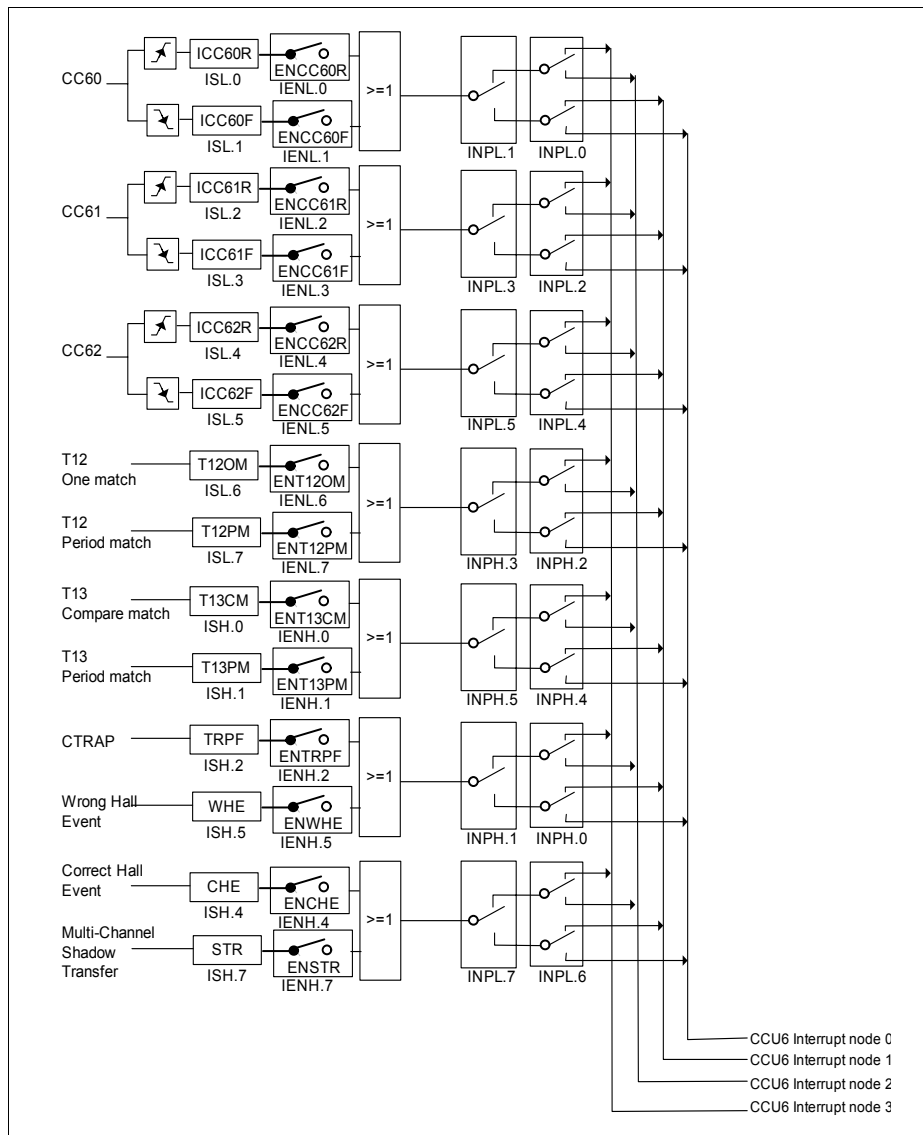


Figure 17 Interrupt Request Sources (Part 4)

3.4.3 Interrupt Priority

Each interrupt source, except for NMI, can be individually programmed to one of the four possible priority levels. The NMI has the highest priority and supersedes all other interrupts. Two pairs of interrupt priority registers (IP and IPH, IP1 and IPH1) are available to program the priority level of each non-NMI interrupt vector.

A low-priority interrupt can be interrupted by a high-priority interrupt, but not by another interrupt of the same or lower priority. Further, an interrupt of the highest priority cannot be interrupted by any other interrupt source.

If two or more requests of different priority levels are received simultaneously, the request of the highest priority is serviced first. If requests of the same priority are received simultaneously, then an internal polling sequence determines which request is serviced first. Thus, within each priority level, there is a second priority structure determined by the polling sequence shown in **Table 18**.

Table 18 Priority Structure within Interrupt Level

Source	Level
Non-Maskable Interrupt (NMI)	(highest)
External Interrupt 0	1
Timer 0 Interrupt	2
External Interrupt 1	3
Timer 1 Interrupt	4
UART Interrupt	5
Timer 2, Fractional Divider, LIN Interrupts	6
ADC Interrupt	7
SSC Interrupt	8
External Interrupt 2	9
External Interrupt [6:3]	10
CCU6 Interrupt Node Pointer 0	11
CCU6 Interrupt Node Pointer 1	12
CCU6 Interrupt Node Pointer 2	13
CCU6 Interrupt Node Pointer 3	14

3.7 Reset Control

The XC866 has five types of reset: power-on reset, hardware reset, watchdog timer reset, power-down wake-up reset, and brownout reset.

When the XC866 is first powered up, the status of certain pins (see **Table 20**) must be defined to ensure proper start operation of the device. At the end of a reset sequence, the sampled values are latched to select the desired boot option, which cannot be modified until the next power-on reset or hardware reset. This guarantees stable conditions during the normal operation of the device.

In order to power up the system properly, the external reset pin $\overline{\text{RESET}}$ must be asserted until V_{DDC} reaches $0.9 \cdot V_{\text{DDC}}$. The delay of external reset can be realized by an external capacitor at $\overline{\text{RESET}}$ pin. This capacitor value must be selected so that V_{RESET} reaches 0.4 V, but not before V_{DDC} reaches $0.9 \cdot V_{\text{DDC}}$.

A typical application example is shown in **Figure 21**. V_{DDP} capacitor value is 300 nF. V_{DDC} capacitor value is 220 nF. The capacitor connected to $\overline{\text{RESET}}$ pin is 100 nF.

Typically, the time taken for V_{DDC} to reach $0.9 \cdot V_{\text{DDC}}$ is less than 50 μs once V_{DDP} reaches 2.3V. Hence, based on the condition that 10% to 90% V_{DDP} (slew rate) is less than 500 μs , the $\overline{\text{RESET}}$ pin should be held low for 500 μs typically. See **Figure 22**.

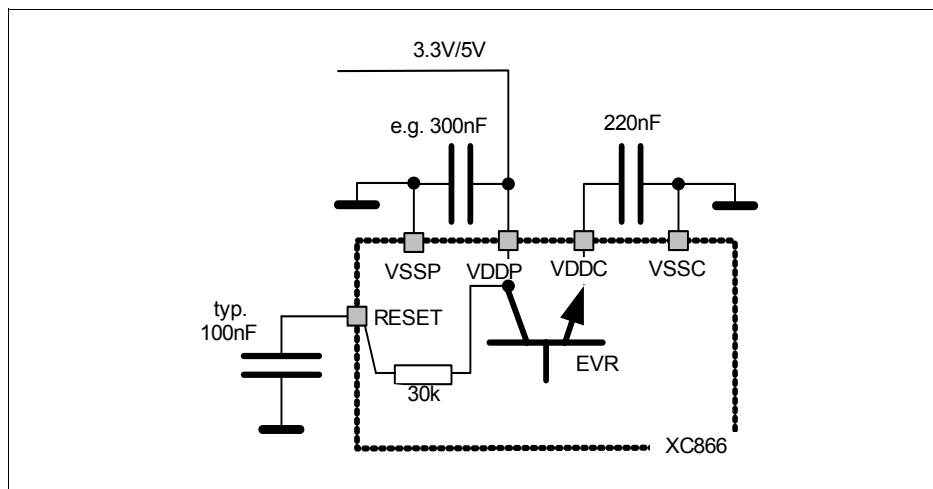


Figure 21 Reset Circuitry

3.11.1 Baud-Rate Generator

The baud-rate generator is based on a programmable 8-bit reload value, and includes divider stages (i.e., prescaler and fractional divider) for generating a wide range of baud rates based on its input clock f_{PCLK} , see **Figure 29**.

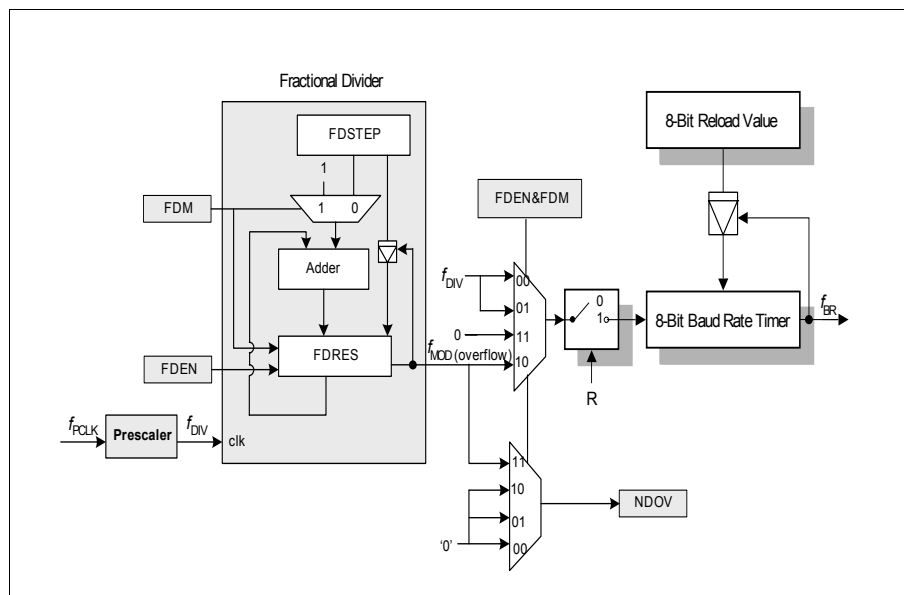


Figure 29 Baud-rate Generator Circuitry

The baud rate timer is a count-down timer and is clocked by either the output of the fractional divider (f_{MOD}) if the fractional divider is enabled ($\text{FDCON.FDEN} = 1$), or the output of the prescaler (f_{DIV}) if the fractional divider is disabled ($\text{FDCON.FDEN} = 0$). For baud rate generation, the fractional divider must be configured to fractional divider mode ($\text{FDCON.FDM} = 0$). This allows the baud rate control run bit BCON.R to be used to start or stop the baud rate timer. At each timer underflow, the timer is reloaded with the 8-bit reload value in register BG and one clock pulse is generated for the serial channel.

Enabling the fractional divider in normal divider mode ($\text{FDEN} = 1$ and $\text{FDM} = 1$) stops the baud rate timer and nullifies the effect of bit BCON.R . See **Section 3.12**.

The baud rate (f_{BR}) value is dependent on the following parameters:

- Input clock f_{PCLK}
- Prescaling factor (2^{BRPRE}) defined by bit field BRPRE in register BCON
- Fractional divider (STEP/256) defined by register FDSTEP
(to be considered only if fractional divider is enabled and operating in fractional divider mode)

Functional Description

3.16 Timer 2

Timer 2 is a 16-bit general purpose timer (THL2) that has two modes of operation, a 16-bit auto-reload mode and a 16-bit one channel capture mode. If the prescaler is disabled, Timer 2 counts with an input clock of PCLK/12. Timer 2 continues counting as long as it is enabled.

Table 29 Timer 2 Modes

Mode	Description
Auto-reload	Up/Down Count Disabled <ul style="list-style-type: none"> Count up only Start counting from 16-bit reload value, overflow at FFFF_H Reload event configurable for trigger by overflow condition only, or by negative/positive edge at input pin T2EX as well Programmable reload value in register RC2 Interrupt is generated with reload event
	Up/Down Count Enabled <ul style="list-style-type: none"> Count up or down, direction determined by level at input pin T2EX No interrupt is generated Count up <ul style="list-style-type: none"> Start counting from 16-bit reload value, overflow at FFFF_H Reload event triggered by overflow condition Programmable reload value in register RC2 Count down <ul style="list-style-type: none"> Start counting from FFFF_H, underflow at value defined in register RC2 Reload event triggered by underflow condition Reload value fixed at FFFF_H
Channel capture	<ul style="list-style-type: none"> Count up only Start counting from 0000_H, overflow at FFFF_H Reload event triggered by overflow condition Reload value fixed at 0000_H Capture event triggered by falling/rising edge at pin T2EX Captured timer value stored in register RC2 Interrupt is generated with reload or capture event

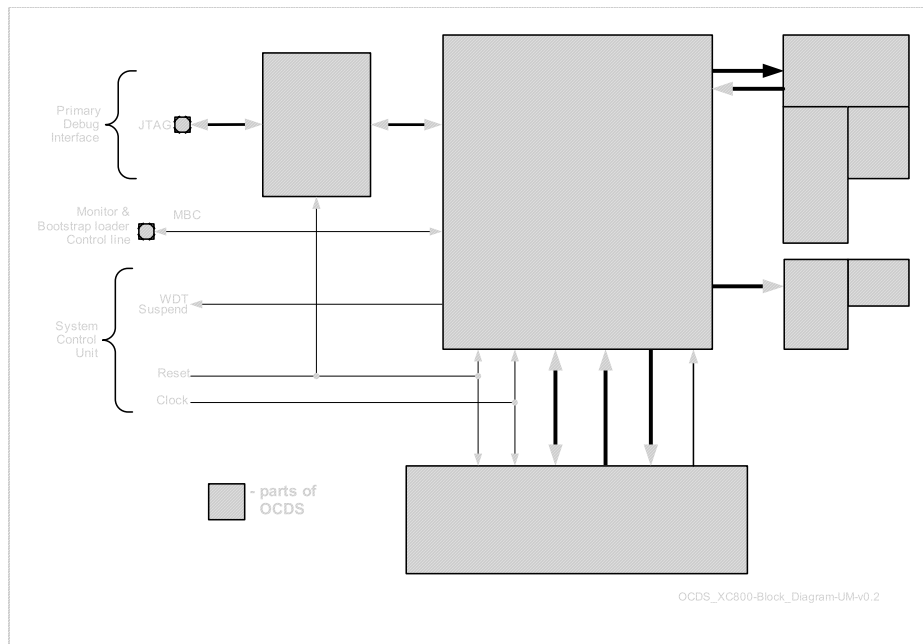


Figure 35 OCDS Block Diagram

3.19.1 JTAG ID Register

This is a read-only register located inside the JTAG module, and is used to recognize the device(s) connected to the JTAG interface. Its content is shifted out when INSTRUCTION register contains the IDCODE command (opcode 04_H), and the same is also true immediately after reset.

The JTAG ID register contents for the XC866 devices are given in **Table 31**.

Table 31 JTAG ID Summary

Device Type	Device Name	JTAG ID
Flash	XC866L-4FR	1010 0083 _H
	XC866-4FR	100F 5083 _H
	XC866L-2FR	1010 2083 _H
	XC866-2FR	1010 1083 _H
	XC866L-1FR	1013 8083 _H
	XC866-1FR	1013 8083 _H

Functional Description
Table 31 JTAG ID Summary

ROM	XC866L-4RR	1013 9083 _H
	XC866-4RR	1013 9083 _H
	XC866L-2RR	1013 9083 _H
	XC866-2RR	1013 9083 _H

3.20 Identification Register

The XC866 identity register is located at Page 1 of address B3_H.

ID
Identity Register
Reset Value: 0000 0010_B

7	6	5	4	3	2	1	0
PRODID					VERID		
r					r		

Field	Bits	Type	Description
VERID	[2:0]	r	Version ID 010 _B
PRODID	[7:3]	r	Product ID 00000 _B

Electrical Parameters

Table 36 ADC Characteristics (Operating Conditions apply; $V_{DDP} = 5V$ Range)

Parameter	Symbol	Limit Values			Unit	Test Conditions/ Remarks
		min.	typ .	max.		
Switched capacitance at the analog voltage inputs	C_{AINSW} CC	–	5	7	pF	2)4)
Input resistance of the reference input	R_{AREF} CC	–	1	2	k Ω	2)
Input resistance of the selected analog channel	R_{AIN} CC	–	1	1.5	k Ω	2)

1) TUE is tested at $V_{AREF} = 5.0 V$, $V_{AGND} = 0 V$, $V_{DDP} = 5.0 V$.

2) Not subject to production test, verified by design/characterization.

3) This represents an equivalent switched capacitance. This capacitance is not switched to the reference voltage at once. Instead of this, smaller capacitances are successively switched to the reference voltage.

4) The sampling capacity of the conversion C-Network is pre-charged to $V_{AREF}/2$ before connecting the input to the C-Network. Because of the parasitic elements, the voltage measured at ANx is lower than $V_{AREF}/2$.

4.3.2 Output Rise/Fall Times

Table 41 Output Rise/Fall Times Parameters (Operating Conditions apply)

Parameter	Symbol	Limit Values		Unit	Test Conditions
		min.	max.		
V_{DDP} = 5V Range					
Rise/fall times ^{1) 2)}	t_R, t_F	–	10	ns	20 pF. ³⁾
V_{DDP} = 3.3V Range					
Rise/fall times ^{1) 2)}	t_R, t_F	–	10	ns	20 pF. ⁴⁾

¹⁾ Rise/Fall time measurements are taken with 10% - 90% of the pad supply.

²⁾ Not all parameters are 100% tested, but are verified by design/characterization and test correlation.

³⁾ Additional rise/fall time valid for $C_L = 20pF - 100pF$ @ 0.125 ns/pF.

⁴⁾ Additional rise/fall time valid for $C_L = 20pF - 100pF$ @ 0.225 ns/pF.

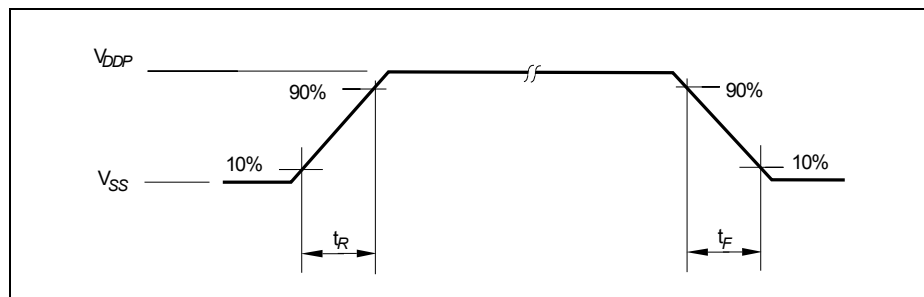





Figure 41 Rise/Fall Times Parameters

4.3.6 SSC Master Mode Timing

Table 46 SSC Master Mode Timing (Operating Conditions apply; $C_L = 50$ pF)

Parameter	Symbol		Limit Values		Unit
			min.	max.	
SCLK clock period	t_0	CC	$2 \cdot T_{SSC}^{1)}$	—	ns
MTSR delay from SCLK 	t_1	CC	0	8	ns
MRST setup to SCLK 	t_2	SR	22	—	ns
MRST hold from SCLK 	t_3	SR	0	—	ns

¹⁾ $T_{SSCmin} = T_{CPU} = 1/f_{CPU}$. When $f_{CPU} = 26.7$ MHz, $t_0 = 74.9$ ns. T_{CPU} is the CPU clock period.

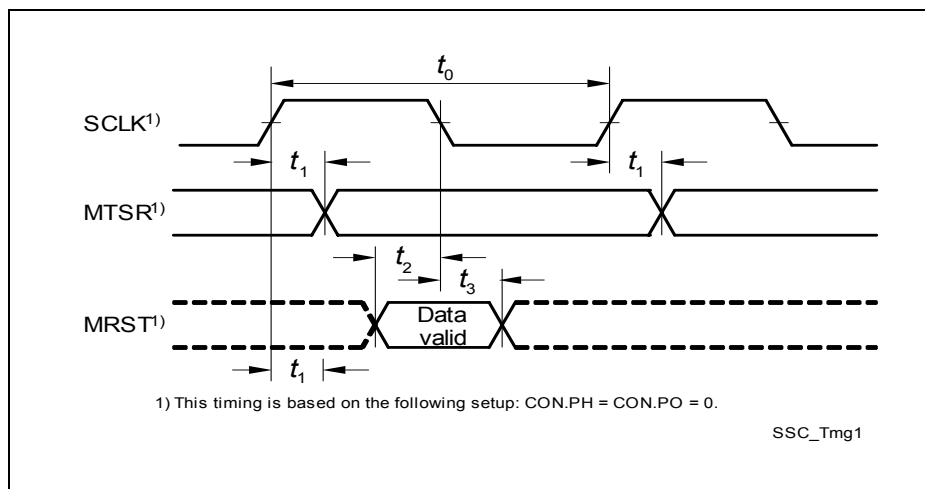


Figure 45 SSC Master Mode Timing